

DO-218 Package



Dimension in inches and (millimeter)

PRIMARY CHARACTERISTICS				
Vrwm	16V to 43V			
Vbr	17.8V to 52.8V			
Рррм (10/1000us)	4600W			
Tj max	175°C			
Polarity	Uni-directional & Bi-directional			
Package	DO-218			

Typical Application



FEATURES

- Glass passivated junction technology
- Low forward voltage drop for Uni-directional polarity
- Fast response time: typical less than 1.0ps from 0 Volts to BV
- TJ = 175°C capability suitable for high reliability
- High surge capability
- Maximum peak power dissipation: 4600 Watts
- Meets ISO7637-2 & ISO16750-2 surge specification (varied by test condition)
- Halogen-Free
- RoHS compliant
- AEC-Q101 qualified



MECHANICAL DATA

Case: DO-218. Molded plastic over glass passivated junction Molding compound meets UL 94V-0 flammability rating

Terminal: Solderable per MIL-STD-750, Method 2026 **Polarity:** Heat sink is anode, Color band denoted positive end (cathode) except Bidirectional.

Typical Application

Use in sensitive electronics protection against voltage transients induced by inductive load switching and lighting. Especially for automotive load dump protection application.

Functional Diagram





Ordering Information

Part Number	Quantity	uantity Packing Option Component Package		Packing Specification	
ALD6SxxA	750	Tape & Reel - 24mm/13" tape	DO-218	EIA STD RS-481	



AOS products are offered in packages with Pb-free plating and compliant to RoHS standards. Please visit <u>https://aosmd.com/sites/default/files/media/AOSGreenPolicy.pdf</u> for additional information.

MAXIMUM RATINGS (25°C ambient temperature unless otherwise specified)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation on 10/1000µs waveform ⁽¹⁾	Рррм	4600	Watts
Peak Pulse Power Dissipation on 10/10000µs waveform ⁽¹⁾	Рррм	3600	Watts
Peak Pulse Current of on 10/1000µs waveform	Іррм	See next table	Amps
Power dissipation on infinite heatsink ($T_c = 25^{\circ}C$)	PD	6	Watts
Peak Forward Surge Current,8.3ms Single Half Sine-Wave, Superimposed on Rated Load. (JEDEC Method)	IFSM	600	Amps
Operating junction and Storage Temperature Range	TJ TSTG	-55 to +175	°C

Note:

1. Non-repetitive current pulse above $T_A = 25 \text{ °C}$

ELECTRICAL CHARACTERISTICS

PART NUMBER		STAND-OFF VC VOLTAGE VB	VOL	KDOWN TAGE V) @IT	TEST CURRENT Ιτ (mA)	MAXIMUM CLAMPING VOLTAGE	MAXIMUM PEAK PULSE CURRENT	MAXIMUM REVERSE LEAKAGE @ VRWM
UNI- POLAR	BI-POLAR	VRWM(V)	MIN	МАХ		@lpp Vc(V)	lpp (A)	IR(μA)
ALD6S16A	ALD6S16CA	16.0	17.80	19.70	5	26.0	177.0	10
ALD6S17A	ALD6S17CA	17.0	18.90	20.90	5	27.6	166.7	10
ALD6S18A	ALD6S18CA	18.0	20.00	22.10	5	29.2	157.6	10
ALD6S20A	ALD6S20CA	20.0	22.20	24.50	5	32.4	142.0	10
ALD6S22A	ALD6S22CA	22.0	24.40	26.90	5	35.5	129.6	10
ALD6S24A	ALD6S24CA	24.0	26.70	29.50	5	38.9	118.3	10
ALD6S26A	ALD6S26CA	26.0	28.90	31.90	5	42.1	109.3	10
ALD6S28A	ALD6S28CA	28.0	31.10	34.40	5	45.4	101.4	10
ALD6S30A	ALD6S30CA	30.0	33.30	36.80	5	48.4	95.2	10
ALD6S33A	ALD6S33CA	33.0	36.70	40.60	5	53.3	86.4	10
ALD6S36A	ALD6S36CA	36.0	40.00	44.20	5	58.1	79.2	10
ALD6S40A	ALD6S40CA	40.0	44.40	49.10	5	64.5	71.4	10
ALD6S43A	ALD6S43CA	43.0	47.80	52.80	5	69.4	66.3	10

Note:

For uni-directional part, the maximum $V_F = 1.8$ V at $I_F = 100$ A measured on 8.3ms single half sine-wave or equivalent square wave, duty cycle = 4 pulses per minute maximum



RATINGS AND CHARACTERISTICS CURVES (TA = 25°C unless otherwise noted)



t - Pulse Width(s)



Soldering Parameters

Reflow Condition		Lead-free assembly		
	-Temperature Min (T _{s(min)})	150°C		
Pre Heat	-Temperature Max (Ts(max))	200°C		
	-Time (min to max) (t _s)	60-120 seconds		
Average ramp up rate	3°C/second max			
T _{s(max)} to T _L - Ramp-up	3°C/second max			
Reflow	-Temperature Min (T∟)	217°C		
	Time (t _L) maintained above T_L	60-150 seconds		
Peak temperature(T _P)		245 ^{+0/-5} °C		
Time within 5°C of actu	20-40 seconds			
Ramp-down Rate	amp-down Rate			
Time 25°C to peak temperature(Tp)		8 minutes max		

Soldering Profile





PART MARKING



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